

MSM27512AS

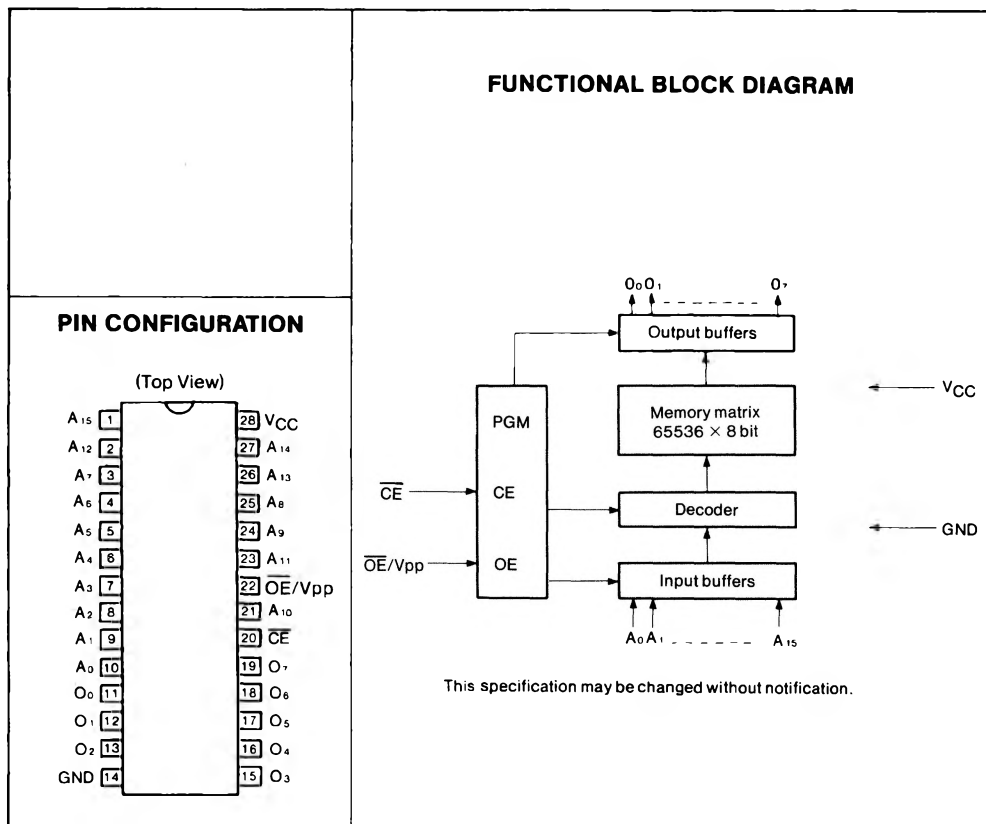
**65536 × 8 BIT UV ERASABLE ELECTRICALLY PROGRAMMABLE
READ-ONLY MEMORY**

GENERAL DESCRIPTION

The MSM27512 is a 65536 words × 8 bit ultraviolet erasable and electrically programmable read-only memory. Users can freely prepare the memory content, which can be easily changed, so the MSM27512 is ideal for microprocessor programs, etc. The MSM27512 is manufactured by the N channel double silicon gate MOS technology and is contained in the 28 pin package.

FEATURES

- +5V single power supply
- 65536 words × 8 bit configuration
- Access time:
 - MAX150 ns (MSM27512-15)
 - MAX200 ns (MSM27512-20)
 - MAX250 ns (MSM27512-25)
- Power consumption:
 - MAX525 mW (during operation)
 - MAX184 mW (during stand-by)
- Perfect static operation
- INPUT/OUTPUT TTL level (three state output)



FUNCTION TABLE

Pins	$\overline{\text{CE}}$ (20)	$\overline{\text{OE}}/\text{Vpp}$ (22)	VCC (28)	Outputs
Mode				
Read	V_{IL}	V_{IL}	+5V	Dout
Output Disable	V_{IL}	V_{IH}	+5V	High impedance
Stand-by	V_{IH}	—	+5V	High impedance
Program	V_{IL}	Vpp	+6V	D_{IN}
Program Inhibit	V_{IH}	Vpp	+6V	High impedance

—; Can be either V_{IL} or V_{IH}

ABSOLUTE MAXIMUM RATINGS

Temperature Under Bias	Ta	$-10^{\circ}\text{C} \sim 80^{\circ}\text{C}$
Storage Temperature	Tstg	$-55^{\circ}\text{C} \sim 125^{\circ}\text{C}$
All Input/Output Voltages	$\text{V}_{\text{IN}}, \text{V}_{\text{OUT}}$	$-0.6\text{V} \sim 13.5\text{V}$
VCC Supply Voltage	VCC	$-0.3\text{V} \sim 7\text{V}$
Program Voltage	Vpp	$-0.6\text{V} \sim 13.5\text{V}$
Power Assembly Voltage	PD	1.5W

The voltage with respect to GND.

ELECTRICAL CHARACTERISTICS**<READ OPERATION>****RECOMMENDED OPERATION CONDITION**

Parameter	Symbol	Limit			Operating Temperature	Remarks	Symbol
		Min.	Typ.	Max.			
VCC Power Supply Voltage	VCC	4.75	5.0	5.25	$0^{\circ}\text{C} \sim 70^{\circ}\text{C}$	$\text{VCC}=5\text{V} \pm 5\%$	V
"H" Level Input Voltage	V_{IH}	2.00	—	6.25			V
"L" Level Input Voltage	V_{IL}	-0.1	—	0.8			V

The voltage with respect to GND

DC CHARACTERISTICS

($V_{CC} = 5V \pm 5\%$, $T_a = 0^\circ C \sim 70^\circ C$)

Parameter	Symbol	Conditions	Limits			Unit
			Min.	Typ.	Max.	
Input Leakage Current	I_{LI}	$V_{IN} = 5.25V$	—	—	10	μA
Output Leakage Current	I_{LO}	$V_{OUT} = 5.25V$	—	—	10	μA
V_{CC} Power Current (Stand-by)	I_{CC1}	$\overline{CE} = V_{IH}$	—	—	35	mA
V_{CC} Power Current (Operation)	I_{CC2}	$\overline{CE} = V_{IL}$	—	—	100	mA
Input Voltage "H" Level	V_{IH}	—	2.0	—	$V_{CC}+1$	V
Input Voltage "L" Level	V_{IL}	—	-0.1	—	0.8	V
Output Voltage "H" Level	V_{OH}	$I_{OH} = -400 \mu A$	2.4	—	—	V
Output Voltage "L" Level	V_{OL}	$I_{OL} = 2.1 \text{ mA}$	—	—	0.45	V

AC CHARACTERISTICS

($V_{CC} = 5V \pm 5\%$, $T_a = 0^\circ C \sim 70^\circ C$)

Parameter	Symbol	Conditions	27512-15		27512-20		27512-25		Unit
			Min.	Max.	Min.	Max.	Min.	Max.	
Address Access Time	t_{ACC}	$\overline{CE} = \overline{OE}/V_{pp} = V_{IL}$	—	150	—	200	—	250	ns
$\overline{CE}$ Access Time	t_{CE}	$\overline{OE}/V_{pp} = V_{IL}$	—	150	—	200	—	250	ns
$\overline{OE}$ Access Time	t_{OE}	$\overline{CE} = V_{IL}$	—	70	—	75	—	100	ns
Output Disable Time	t_{DF}	$\overline{CE} = V_{IL}$	0	50	0	55	0	60	ns

Measurement condition

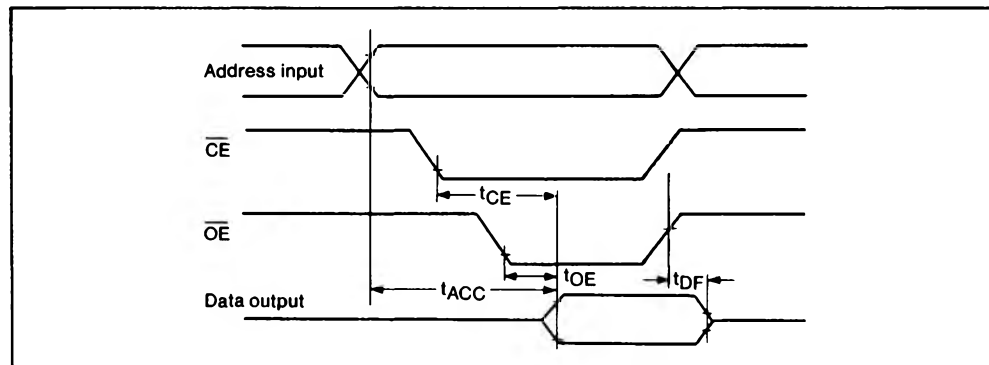
Input pulse level 0.45V and 2.4V

Input timing reference level 0.8V and 2.0V

Output load 1TTL GATE + 100pF

Output timing reference level 0.8V and 2.0V

TIME CHART



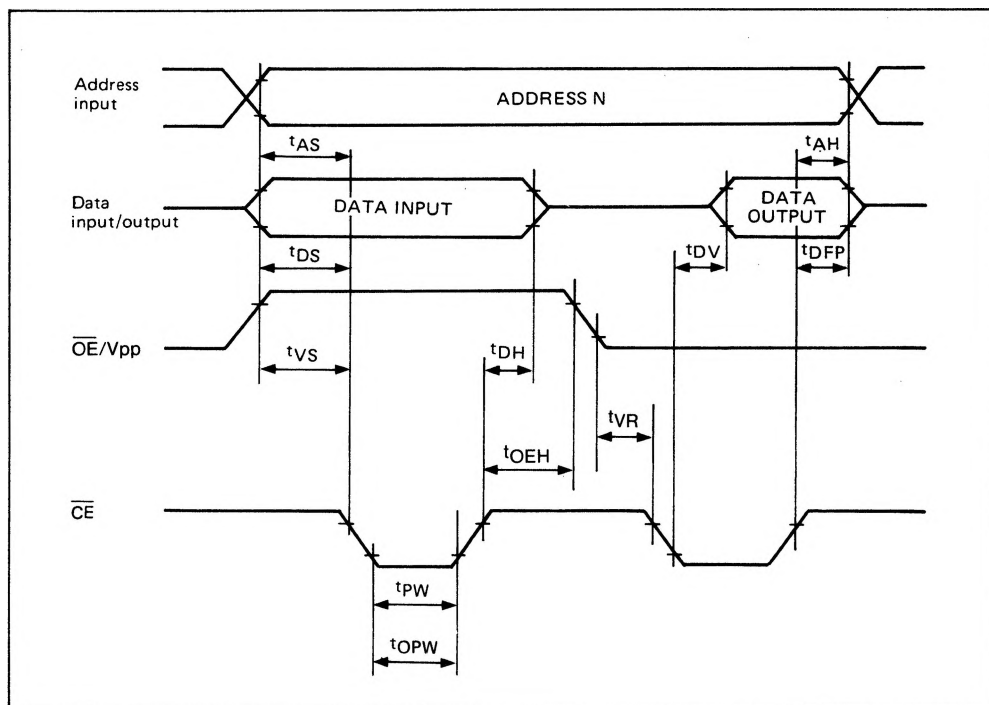
DC CHARACTERISTICS(V_{CC} = 6V±5%, V_{pp} = 12.5V±0.5V, T_a = 25°C±5°C)

Parameter	Symbol	Conditions	Limits			Unit
			Min.	Typ.	Max.	
Input Leakage Current	I _{LI}	V _{IN} = 5.25V	–	–	10	μA
V _{pp} Power Current	I _{pp}	$\overline{CE} = V_{IL}$	–	–	50	mA
V _{CC} Power Current	I _{CC}	–	–	–	100	mA
Input Voltage “H” Level	V _{IH}	–	2.0	–	V _{CC} +1	V
Input Voltage “L” Level	V _{IL}	–	–0.1	–	0.8	V
Output Voltage “H” Level	V _{OH}	I _{OH} = –400 μA	2.4	–	–	V
Output Voltage “L” Level	V _{OL}	I _{OL} = 2.1 mA	–	–	0.45	V

AC CHARACTERISTICS(V_{CC} = 6V±0.25V, V_{pp} = 12.5V±0.5V, T_a = 25°C±5°C)

Parameter	Symbol	Conditions	Limits			Unit
			Min.	Typ.	Max.	
Address Set-up Time	t _{AS}	–	2	–	–	μs
Data Set-up Time	t _{DS}	–	2	–	–	μs
Address Hold Time	t _{AH}	–	0	–	–	μs
Data Hold Time	t _{DH}	–	2	–	–	μs
$\overline{CE}$ Enable to Output Float Delay	t _{DFP}	–	0	–	130	ns
V _{pp} Power Set-up Time	t _{VS}	–	2	–	–	μs
$\overline{CE}$ Initial Program Pulse Width	t _{PW}	–	0.95	1.0	1.05	ms
$\overline{CE}$ Overprogram Pulse Width	t _{OPW}	–	2.85	–	78.75	ms
$\overline{OE}$ /V _{pp} Hold Time	t _{OEh}	–	2	–	–	μs
Data Valid from $\overline{CE}$	t _{DV}	–	–	–	1	μs
$\overline{OE}$ /V _{pp} Recovery Time	t _{VR}	–	2	–	–	μs

TIME CHART



CAPACITANCE

($T_a = 25^\circ\text{C}$, $f = 1\text{ MHz}$)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit.
Input Capacitance	C_{IN}	$V_{IN} = 0V$	—	4	6	pF
Output Capacitance	C_{OUT}	$V_{OUT} = 0V$	—	8	12	pF